RATING									
NATING	OPERATING TEMPERATURE RANGE OPERATING		-30°C TO 85°C(NO	-30°C TO 85°C (NOTE 1) STORAGE TEMPERATURE RAI		URE RANGE	-10°C TO 60°C (NOTE 2)		
			40% TO 80%		STORAGE HUMIDITY F	PANGE	40% TO 70% (NOTE		
	HUMIDITY RANGE VOLTAGE		250V AC		TIOWIDITTI	VOLTAGE	<u> </u>		
	CURRENT		AWG 22 TO 26 : AWG 28 :	2A 1A	UL • CSA RATING	CURRENT	AWG 22 : AWG 24 TO 28 :	2A 1A	
				0. 5A				0. 5A	
			SPEC	IFICAT	IONS				
רן	ГЕМ		TEST METHOD			REQ	UIREMENTS	QT	АТ
CONSTF	RUCTION				•			•	
			AND BY MEASURING INSTRUMENT.		ACCC	ACCORDING TO DRAWING.			X
MARKING	10 0114 0 4		D VISUALLY.					Х	X
	IC CHARA RESISTANCE				30m(Ω M AX.		1	
		Ì	100mA (DC OR 1000 Hz).					X	_
INSULATION RESISTANC		500V DC.	500V DC.			1000MΩ MIN.			_
VOLTAGE P		650V AC	650V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.			
MECHAN	NICAL CHA		PISTICS					X	
MECHANIC			INSERTIONS AND EXTR	ACTIONS.	1① CC	NTACT RES	ISTANCE: 30mΩ MAX.	Г	
OPERATION			to himze inectitions /ind Extra energy.			② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
VIBRATION			ICY 10 TO 55 Hz, SINGLE AT 2 h, FOR 3 DIRECTIO			① NO ELECTRICAL DISCONTINUITY OF 1µs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS. X			_
SHOCK			URATION OF PULSE 11 r						_
ENVIRO!	NMENTAL		CTERISTICS					1 ^	
RAPID CHA			TURE -55→5 TO 35→+85	→5 TO 35 °	C ① CC	NTACT RESI	STANCE: 30mΩ MAX.	X	
TEMPERATURE		TIME				② INSULATION RESISTANCE: $1000 \text{M}\Omega$ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
DAMP HEAT (STEADY STATE)		EXPOSED	D AT 40 ± 2 °C, 90 TO 95 %, 96 h.		2 INS 3 NO	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
COUN	ום דו	ESCRIPTIO	N OF REVISIONS	а	ESIGNED		CHECKED	DA	TE
COUN	IT DI	ESCRIPTIO	N OF REVISIONS	D	ESIGNED		CHECKED	DA	TE
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_	IT DI	ESCRIPTIO	N OF REVISIONS	D	ESIGNED	CHECKED	TS. SAKATA TS. KUMAZAWA		2. 03
_	IT DI	ESCRIPTIO	N OF REVISIONS	D	ESIGNED	CHECKED	TS. SAKATA TS. KUMAZAWA KT. ISHII	08. 1 08. 1 08. 1	2. 03 2. 03 2. 02
_	IT DI	ESCRIPTIO	N OF REVISIONS	D	ESIGNED	CHECKED	TS. SAKATA TS. KUMAZAWA KT. ISHII KT. [SHII]	08. 1 08. 1 08. 1	2. 03 2. 03 2. 02
▲			N OF REVISIONS		ESIGNED	CHECKED DESIGNED DRAWN	TS. SAKATA TS. KUMAZAWA KT. ISHII	08. 1 08. 1 08. 1	2. 03 2. 03 2. 02
▲	ualification Tes	t AT:Assui		st		CHECKED DESIGNED DRAWN	TS. SAKATA TS. KUMAZAWA KT. ISHII KT. [SHII]	08. 1 08. 1 08. 1	2. 03 2. 03 2. 02

APPLICABLE STANDARD

SPECIFICATIONS						
ITEM	TEST METHOD	REQUIREMENTS	QT	AT		
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 250°C WITHIN 10 sec. MIN 230°C WITHIN 60 sec. 《PREHEATING AREA》 150 TO 180°C 90 TO 120 sec. PUT THROUGH IN REFROW FUMACE TWICE. FEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNEVCTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :290±10°C, SOLDERING TIME :3s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	_		
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230±5°C FOR IN IMMERSION , DURATION, 3 s.	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	Х	1		

REMARKS

NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD , AFTER PCB BOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION.

NOTE 3:THE TEMPERATURE PROFILE SHALL BE APPLIED WITHIN 168 HOURS AFTER OPENING MOISTURE-PROOF PACKAGING. WHEN 168 HOURS PASSED AFTER OPENING , APPLY THE BOTTOM REQUIREMENTS.

《REFLOW AREA》

MAX 240°C WITHIN 10 sec.
MIN 230°C WITHIN 60 sec.

《PREHEATING AREA》

150 TO 180°C 90 TO 120 s.

Unless otherwise specifid , refer to JIS C 5402.

Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWING NO.		ELC4-081533-02		
HRS	SPECIFICATION SHEET	PART NO.	DF11-14DP-2V (57)			
11.0	HIROSE ELECTRIC CO., LTD.	CODE NO	CL543	-0590-5-57	\$	2/2